

**Iupilon S-2000VR**

PC

Mitsubishi Engineering-Plastics Corporation

| <b>Processing/Physical Characteristics</b> | <b>Value</b> | <b>Unit</b>            | <b>Test Standard</b> |
|--------------------------------------------|--------------|------------------------|----------------------|
| <b>ISO Data</b>                            |              |                        |                      |
| Melt volume-flow rate, MVR                 | 9            | cm <sup>3</sup> /10min | ISO 1133             |
| Temperature                                | 300          | °C                     | -                    |
| Load                                       | 1.2          | kg                     | -                    |
| Melt flow index, MFI                       | 10           | g/10min                | ISO 1133             |
| Temperature                                | 300          | °C                     | -                    |
| Load                                       | 1.2          | kg                     | -                    |
| Molding shrinkage, parallel                | 0.6          | %                      | ISO 294-4, 2577      |
| Molding shrinkage, normal                  | 0.6          | %                      | ISO 294-4, 2577      |

| <b>Mechanical properties</b>          | <b>Value</b> | <b>Unit</b>       | <b>Test Standard</b> |
|---------------------------------------|--------------|-------------------|----------------------|
| <b>ISO Data</b>                       |              |                   |                      |
| Tensile Modulus                       | 2400         | MPa               | ISO 527              |
| Yield stress                          | 61           | MPa               | ISO 527              |
| Yield strain                          | 5.6          | %                 | ISO 527              |
| Strain at break                       | 110          | %                 | ISO 527              |
| Flexural modulus, 23°C                | 2300         | MPa               | ISO 178              |
| Flexural strength                     | 93           | MPa               | ISO 178              |
| Charpy impact strength, +23°C         | N            | kJ/m <sup>2</sup> | ISO 179/1eU          |
| Charpy notched impact strength, +23°C | 76           | kJ/m <sup>2</sup> | ISO 179/1eA          |

| <b>Thermal properties</b>                   | <b>Value</b> | <b>Unit</b> | <b>Test Standard</b> |
|---------------------------------------------|--------------|-------------|----------------------|
| <b>ISO Data</b>                             |              |             |                      |
| Temp. of deflection under load, 1.80 MPa    | 129          | °C          | ISO 75-1/-2          |
| Temp. of deflection under load, 0.45 MPa    | 143          | °C          | ISO 75-1/-2          |
| Coeff. of linear therm. expansion, parallel | 65           | E-6/K       | ISO 11359-1/-2       |
| Coeff. of linear therm. expansion, normal   | 66           | E-6/K       | ISO 11359-1/-2       |
| Burning behav. at 1.5 mm nom. thickn.       | V-2          | class       | IEC 60695-11-10      |
| Thickness tested                            | 1.5          | mm          | -                    |
| Yellow Card available                       | yes          | -           | -                    |
| Burning behav. at thickness h               | V-2          | class       | IEC 60695-11-10      |
| Thickness tested                            | 0.4          | mm          | -                    |
| Yellow Card available                       | yes          | -           | -                    |

| <b>Electrical properties</b> | <b>Value</b> | <b>Unit</b> | <b>Test Standard</b> |
|------------------------------|--------------|-------------|----------------------|
| <b>ISO Data</b>              |              |             |                      |
| Relative permittivity, 1MHz  | 3.1          | -           | IEC 62631-2-1        |
| Dissipation factor, 1MHz     | 90           | E-4         | IEC 62631-2-1        |
| Volume resistivity           | 3E14         | Ohm*m       | IEC 62631-3-1        |
| Surface resistivity          | 6E15         | Ohm         | IEC 62631-3-2        |
| Electric strength            | 31           | kV/mm       | IEC 60243-1          |
| Comparative tracking index   | 325          | -           | IEC 60112            |

| <b>Other properties</b> | <b>Value</b> | <b>Unit</b>       | <b>Test Standard</b> |
|-------------------------|--------------|-------------------|----------------------|
| Water absorption        | 0.24         | %                 | Sim. to ISO 62       |
| Density                 | 1200         | kg/m <sup>3</sup> | ISO 1183             |

| <b>Processing Recommendation Injection Molding</b> | <b>Value</b> | <b>Unit</b> | <b>Test Standard</b> |
|----------------------------------------------------|--------------|-------------|----------------------|
| Pre-drying - Temperature                           | 120          | °C          | -                    |
| Pre-drying - Time                                  | 4 - 8        | h           | -                    |
| Mold temperature                                   | 70 - 100     | °C          | -                    |
| Zone 1                                             | 270 - 300    | °C          | -                    |
| Zone 2                                             | 270 - 300    | °C          | -                    |
| Zone 3                                             | 270 - 300    | °C          | -                    |
| Nozzle temperature                                 | 270 - 300    | °C          | -                    |

**Characteristics**

**Processing**

Injection Molding

**Additives**

Release agent

**Applications**

General Purpose

**Regional Availability**

North America, Europe, Asia Pacific, South and Central America, Near East/Africa